

## **Spread-Spectrum Crystal Multiplier**

#### **General Description**

The MAX31180 is a low-jitter, crystal-based clock generator with an integrated phase-locked loop (PLL) to generate spread-spectrum clock outputs from 16MHz to 134MHz. The device is pin-programmable to select the clock multiplier rate as well as the dither magnitude. The MAX31180 has a spread-spectrum disable mode and a power-down mode to conserve power.

#### **Applications**

Automotive

Cable Modems

Cell Phones

Computer Peripherals

Copiers

Infotainment

PCs

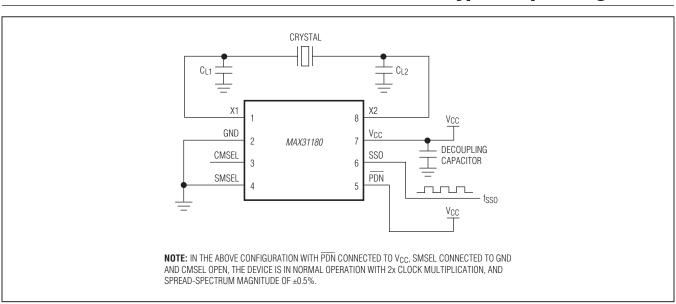
**Printers** 

#### **Features**

- ♦ Generates Spread-Spectrum Clocks from 16MHz to 134MHz
- ♦ Selectable Clock Multiplier Rates of 1x, 2x, and 4x
- **♦** Center Spread-Spectrum Dithering
- ♦ Selectable Spread-Spectrum Modulation Magnitudes of ±0.5%, ±1.0%, and ±1.5%
- ♦ Spread-Spectrum Disable Mode
- ♦ Low Cycle-to-Cycle Jitter
- ♦ Power-Down Mode with High-Impedance Output
- **♦ Low Power Consumption**
- ♦ 3.0V to 3.6V Single-Supply Operation
- ♦ -40°C to +125°C Operating Temperature Range
- ♦ Small 8-Pin µSOP Package

Ordering Information appears at end of data sheet.

#### **Typical Operating Circuit**



For related parts and recommended products to use with this part, refer to: www.maximintegrated.com/MAX31180.related

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#### **ABSOLUTE MAXIMUM RATINGS**

(Voltages relative to GND.)	Operating Temperature Range40°C to +125°C
Voltage Range on V <sub>CC</sub> 0.3V to +4.3V	Storage Temperature Range55°C to +125°C
Voltage Range on Any Pin0.3V to (V <sub>CC</sub> + 0.3V),	Lead Temperature (soldering, 10s)+300°C
not to exceed +4.3V	Soldering Temperature (reflow)+260°C
Continuous Power Dissipation (T <sub>A</sub> = +70°C)	
μSOP (derate 4.5mW/°C above +70°C)362mW	

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

#### RECOMMENDED OPERATING CONDITIONS

 $(T_A = -40^{\circ}C \text{ to } +125^{\circ}C, \text{ unless otherwise noted.})$ 

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Supply Voltage	V <sub>CC</sub>	(Note 1)	3.0		3.6	V
Input Logic 1	V <sub>IH</sub>		0.8 x V <sub>CC</sub>		V <sub>CC</sub> + 0.3	٧
Input Logic 0	V <sub>IL</sub>		V <sub>GND</sub> - 0.3		0.2 x V <sub>CC</sub>	V
Input Logic Open	l <sub>IF</sub>	0V < V <sub>IN</sub> < V <sub>CC</sub> (Note 2)			±1	μΑ
Input Leakage	I <sub>IL</sub>	$0V < V_{IN} < V_{CC}$ (Note 3)			±80	μΑ
		f <sub>SSO</sub> < 67MHz			15	
SSO Load	C <sub>SSO</sub>	67MHz ≤ f <sub>SSO</sub> < 101MHz			10	рF
		101MHz ≤ f <sub>SSO</sub> < 134MHz			7	
Crystal or Clock Input Frequency	f <sub>IN</sub>		16.0		33.4	MHz
Crystal ESR	X <sub>ESR</sub>				90	Ω
Clock Input Duty Cycle	FINDC		40		60	%
Crystal Parallel Load Capacitance	CL	(Note 4)			18	рF

# **Spread-Spectrum Crystal Multiplier**

#### DC ELECTRICAL CHARACTERISTICS

 $(V_{CC} = +3.0V \text{ to } +3.6V, T_A = -40^{\circ}\text{C to } +125^{\circ}\text{C}, \text{ unless otherwise noted.})$ 

PARAMETER	SYMBOL	CONDITIONS MIN TYP MAX		MAX	UNITS	
Supply Current	I <sub>CC1</sub>	$C_{SSO}$ = 15pF, $f_{SSO}$ = 16MHz			15	mA
Power-Down Current	Icca	PDN = GND, all input pins open			200	μΑ
Output Leakage (SSO)	I <sub>OZ</sub>	PDN = GND	-1		+1	μΑ
Low-Level Output Voltage (SSO)	V <sub>OL</sub>	$I_{OL} = 4mA$			0.4	V
High-Level Output Voltage (SSO)	V <sub>OH</sub>	I <sub>OH</sub> = -4mA	2.4			V
Input Capacitance (X1/X2)	C <sub>IN</sub>	(Note 5)		5		рF

#### **AC ELECTRICAL CHARACTERISTICS**

( $V_{CC}$  = +3.0 to +3.6V,  $T_A$  = -40°C to +125°C, unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
CCO Duty Ovala	SSODC	Measured at V <sub>CC</sub> /2, CMSEL = 0 or open	40		60	%
SSO Duty Cycle SSOI		Measured at V <sub>CC</sub> /2, CMSEL = 1	30		70	%
Rise Time	t <sub>R</sub>	(Note 6)		1.6		ns
Fall Time	t <sub>F</sub>	(Note 6)		1.6		ns
Peak Cycle-to-Cycle Jitter	tu	$f_{SSO} = 16MHz$ , $T_A = -40 \text{ to } +85^{\circ}\text{C}$ , 10,000 cycles (Note 5)		75		ps
Power-Up Time	t <sub>POR</sub>	PDN pin (Note 7)			11	ms
Power-Down Time	t <sub>PDN</sub>	PDN pin (Note 8)			100	ns
Dither Rate	fDITHER	(Note 9)		f <sub>IN</sub> /992		

Note 1: All voltages referenced to ground.

Note 2: Maximum source/sink current applied to input to be considered an open. Typical voltage range between 0.4 x  $V_{CC}$  and 0.55 x  $V_{CC}$ .

Note 3: Applicable to pins CMSEL, SMSEL, and PDN.

**Note 4:** See information about  $C_{L,1}$  and  $C_{L,2}$  in the *Applications Information* section at the end of the data sheet.

Note 5: Not production tested.

Note 6: For 7pF load.

Note 7: Time between PDN deasserted to output active.

**Note 8:** Time between PDN asserted to output high impedance.

Note 9: Guaranteed by design.

## **Spread-Spectrum Crystal Multiplier**

### **Typical Operating Characteristics**

 $(V_{CC} = 3.3V, T_A = +25^{\circ}C, unless otherwise noted.)$ 

42

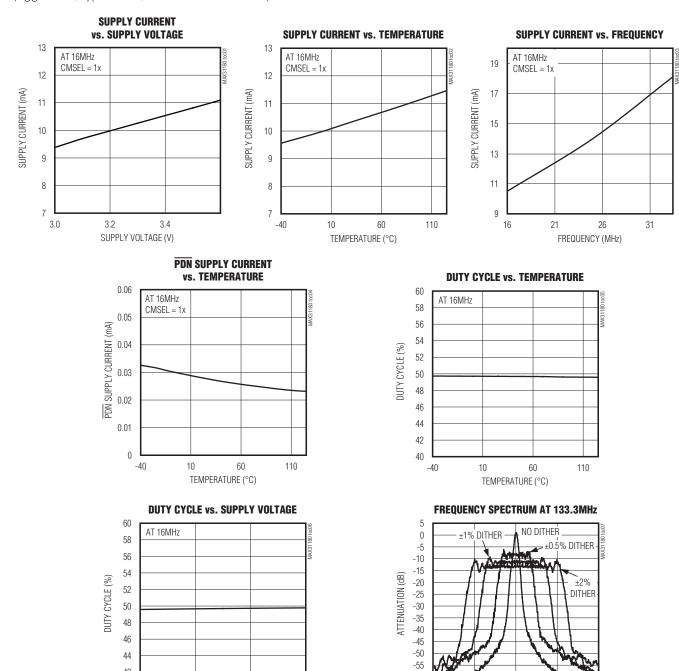
40

3.0

3.2

SUPPLY VOLTAGE (V)

3.4



Maxim Integrated 4

3.6

-60

-65

129.3

131.3

AT 133.3MHz

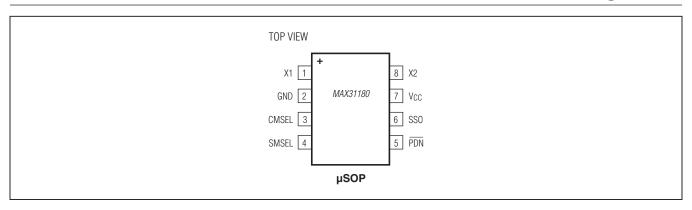
133.3

OUTPUT FREQUENCY (MHz)

137.3

# **Spread-Spectrum Crystal Multiplier**

## **Pin Configuration**

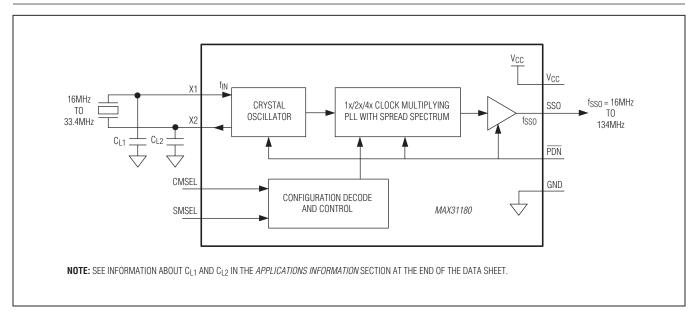


## **Pin Description**

PIN	NAME	FUNCTION
1	X1	Crystal Drive/Clock Input. A crystal with the proper loading capacitors is connected across X1 and X2. Instead of a crystal, a clock can be applied at the X1 input.
2	GND	Signal Ground
3	CMSEL	Clock Multiplier Select. Tri-level digital input. $0 = 1x$ $Open = 2x$ $1 = 4x$
4	SMSEL	Spread-Spectrum Magnitude Select. Tri-level digital input. $0 = \pm 0.5\%$ Open = $\pm 1.0\%$ $1 = \pm 1.5\%$
5	PDN	Active-Low Power-Down/Spread-Spectrum Disable. Tri-level digital input.  0 = Power-Down/SSO Three-Stated  Open = Power-Up/Spread Spectrum Disabled  1 = Power-Up/Spread Spectrum Enabled
6	SSO	Spread-Spectrum Clock Multiplier Output. Outputs a 1x, 2x, or 4x spread-spectrum version of the crystal or clock applied at the X1/X2 pins.
7	V <sub>CC</sub>	Supply Voltage
8	X2	Crystal Drive Output. A crystal with the proper loading capacitors is connected across X1 and X2. If a clock is connected to X1, then X2 should be left open circuit.

## **Spread-Spectrum Crystal Multiplier**

### **Block Diagram**



### **Detailed Description**

The MAX31180 is a crystal multiplier with center spread-spectrum capability. A 16MHz to 33.4MHz crystal is connected to the X1 and X2 pins. Alternately, a 16MHz to 33.4MHz clock can be applied to X1 in place of the crystal. In such applications, X2 would be left open circuit. Using the CMSEL input, the user selects whether the attached crystal or input clock is multiplied by 1, 2, or 4. The MAX31180 is capable of generating spread-spectrum clocks from 16MHz to 134MHz.

The PLL can dither the output clock about its center frequency at a user-selectable magnitude. Using the SMSEL input, the user selects the dither magnitude. The PDN input can be used to place the device into a low-power standby mode where the SSO output is three-stated. If the PDN pin is open, the SSO output is active but

the spread-spectrum dithering is disabled. The spread-spectrum dither rate is fixed at f<sub>IN</sub>/992 to keep the dither rate above the audio frequency range. On power-up, the output clock (SSO) remains three-stated until the PLL reaches a stable frequency (f<sub>SSO</sub>) and dither (f<sub>DITHER</sub>).

### **Applications Information**

#### **Crystal Selection**

The MAX31180 requires a parallel resonating crystal operating in the fundamental mode, with an ESR of less than  $90\Omega$ . The crystal should be placed very close to the device to minimize excessive loading due to parasitic capacitances.

#### **Oscillator Input**

When driving the MAX31180 using an external oscillator clock, consider the input (X1) to be high impedance.

## **Spread-Spectrum Crystal Multiplier**

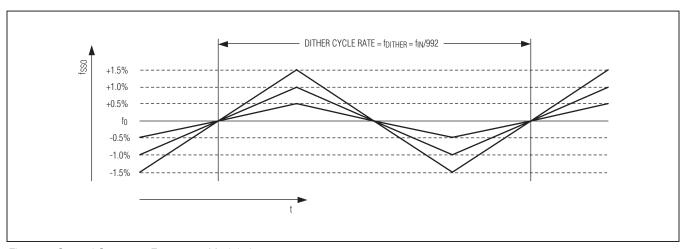


Figure 1. Spread-Spectrum Frequency Modulation

#### **Crystal Capacitor Selection**

The load capacitors  $C_{L1}$  and  $C_{L2}$  are selected based on the crystal specifications (from the data sheet of the crystal used). The crystal parallel load capacitance is calculated as follows:

$$C_L = \frac{C_{L1} \times C_{L2}}{C_{I1} + C_{I2}} + C_{IN}$$
 Equation 1

For the MAX31180 use  $C_{L1} = C_{L2} = C_{LX}$ . In this case, the equation then reduces to:

$$C_L = \frac{C_{LX}}{2} + C_{IN}$$
 Equation 2

where  $C_{L1} = C_{L2} = C_{LX}$ .

Equation 2 is used to calculate the values of  $C_{L1}$  and  $C_{L2}$  based on values on  $C_L$  and  $C_{IN}$  noted in the *Recommended Operating Conditions* and *DC Electrical Characteristics*.

#### **Power-Supply Decoupling**

To achieve best results, it is highly recommended that a decoupling capacitor is used on the IC power-supply pins. Typical values of decoupling capacitors are 0.001 $\mu$ F and 0.1 $\mu$ F. Use a high-quality, ceramic, surface-mount capacitor, and mount it as close as possible to the V<sub>CC</sub> and GND pins of the IC to minimize lead inductance.

#### **Layout Considerations**

As noted earlier, the crystal should be placed very close to the device to minimize excessive loading due to parasitic capacitances. Care should also be taken to minimize loading on pins that could be open as a programming option (SMSEL and CMSEL). Coupling on inputs due to clocks should be minimized.

## **Spread-Spectrum Crystal Multiplier**

#### **Ordering Information**

PART	<b>TEMP RANGE</b>	PIN-PACKAGE
MAX31180AUA+	-40°C to +125°C	8 μSOP
MAX31180AUA+T	-40°C to +125°C	8 µSOP
MAX31180AUA/V+	-40°C to +125°C	8 μSOP
MAX31180AUA/V+T	-40°C to +125°C	8 µSOP

<sup>+</sup>Denotes a lead(Pb)-free/RoHS-compliant package.

#### **Package Information**

For the latest package outline information and land patterns (footprints), go to <a href="https://www.maximintegrated.com/packages">www.maximintegrated.com/packages</a>. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

PACKAGE	PACKAGE	OUTLINE	LAND
TYPE	CODE	NO.	PATTERN NO.
8 µSOP	U8+1	<u>21-0036</u>	90-0092

T = Tape and reel.

N denotes an automotive qualified part.

## **Spread-Spectrum Crystal Multiplier**

#### **Revision History**

REVISION NUMBER	REVISION DATE	DESCRIPTION	PAGES CHANGED
0	12/12	Initial release	_
1	3/13	Added automotive qualified parts to Ordering Information	8



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